

# Wire bonding equipment for optical communication devices

We have expanded the scope of ultra precision die bonding in our optical communication devices at Minder-Hightech. Our die bonding machine use light signals to precisely place tiny parts.

Automatic Wire Bonder LED / Photonics Die Bonding Wire Bonding Lens Attach

We are building a production system consistently performs designing, parts processing, assembling and local response. We can always work one by one with the best performance. Coating width digitally ...

Explore 3 top manufacturers and suppliers of Wire Bonding Equipment in our comprehensive photonics buyers" guide.

Palomar&#174; Technologies is a leading supplier of automated microelectronic assembly machines and contract assembly services with specialization in precision die attach, wire bonding and vacuum ...

We design, manufacture, and sell Thermosonic Ball and Wedge Wire Bonders, Peg Bonders, Epoxy and Silver-Glass Die Bonders, and more. Explore our versatile range of equipment and adjustable heated ...

Palomar&#174; Technologies is a leading supplier of automated microelectronic assembly machines and contract assembly services with specialization in precision die ...

Find all you need for professionally buying photonic wire bonding equipment: a comprehensive expert-curated directory of suppliers, scientific and technical background information, and an interactive AI ...

Manufacturer of Manual Wire Bonders,Semi-Auto Wire Bonders,Full-Auto Wire Bonders. TPT Wire Bonders, ASM Wire Bonders.bonder,wire bonder,wire bonding,bonding gold wire,wedge ...

The 4524AD Programmable Digital Ball Bonder provides excellent repeatability needed for gold ball bonding applications, such as: optoelectronic modules, ...

MPT is AS9100D ISO 9001:2015, and ITAR registered. Micro-Precision Technologies also has a number of Manual Wedge Ball Bonders and Eutectic die bonders.

A major packaging challenge facing the industry is optical coupling between multiple integrated photonic components together with low insertion loss, in a cost effective manner, into a package suitable for ...

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